HALOGEN

FREE

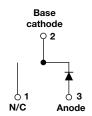


### Vishay High Power Products

# **HEXFRED®**

# **Ultrafast Soft Recovery Diode, 8 A**





PRODUCT SUMMARY								
$V_{R}$	1200 V							
V <sub>F</sub> at 8 A at 25 °C	3.3 V							
I <sub>F(AV)</sub>	8 A							
t <sub>rr</sub> (typical)	28 ns							
T <sub>J</sub> (maximum)	150 °C							
Q <sub>rr</sub> (typical)	140 nC							
dl <sub>(rec)M</sub> /dt (typical) at 125 °C	85 A/µs							
I <sub>RRM</sub> (typical)	4.5 A							

### **FEATURES**

- Ultrafast recovery
- Ultrasoft recovery
- Very low I<sub>RRM</sub>
- Very low Q<sub>rr</sub>
- · Specified at operating conditions
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Halogen-free according to IEC 61249-2-21 definition
- Compliant to RoHS directive 2002/95/EC
- AEC-Q101 qualified

#### **BENEFITS**

- · Reduced RFI and EMI
- · Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- · Reduced parts count

#### **DESCRIPTION**

VS-HFA08TB120S is a state of the art ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 1200 V and 8 A continuous current, the VS-HFA08TB120S is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I<sub>RRM</sub>) and does not exhibit any tendency to "snap-off" during the tb portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED VS-HFA08TB120S is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS					
Cathode to anode voltage	V <sub>R</sub>		1200	V					
Maximum continuous forward current	I <sub>F</sub>	T <sub>C</sub> = 100 °C	8						
Single pulse forward current	I <sub>FSM</sub>		130	Α					
Maximum repetitive forward current	I <sub>FRM</sub>		32						
Mayimum naugudianination	В	T <sub>C</sub> = 25 °C	73.5	W					
Maximum power dissipation	P <sub>D</sub>	T <sub>C</sub> = 100 °C	29	VV					
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		- 55 to + 150	°C					

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### VS-HFA08TB120SPbF

### Vishay High Power Products

# HEXFRED® Ultrafast Soft Recovery Diode, 8 A



<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Cathode to anode breakdown voltage	V <sub>BR</sub>	Ι <sub>R</sub> = 100 μΑ	1200	-	-				
		I <sub>F</sub> = 8.0 A	-	2.6	3.3	V			
Maximum forward voltage	$V_{FM}$	I <sub>F</sub> = 16 A	-	3.4	4.3				
		I <sub>F</sub> = 8.0 A, T <sub>J</sub> = 125 °C	-	2.4	3.1				
Maximum reverse	,	V <sub>R</sub> = V <sub>R</sub> rated	-	0.31	10				
leakage current	I <sub>RM</sub>	$T_J = 125  ^{\circ}\text{C},  V_R = 0.8  \text{x}  V_R  \text{rated}$	-	135	1000	μΑ			
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 200 V	-	11	20	pF			
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body	-	8.0	-	nH			

<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS		
	t <sub>rr</sub>	$I_F = 1.0 \text{ A}, dI_F/dt = 200$	A/μs, V <sub>R</sub> = 30 V	-	28	-			
Reverse recovery time	t <sub>rr1</sub>	T <sub>J</sub> = 25 °C		-	63	95	ns		
	t <sub>rr2</sub>	T <sub>J</sub> = 125 °C		-	106	160			
Dools recovery assument	I <sub>RRM1</sub>	T <sub>J</sub> = 25 °C		-	4.5	8.0	- A		
Peak recovery current	I <sub>RRM2</sub>	T <sub>J</sub> = 125 °C	$I_F = 8.0 \text{ A}$ $dI_F/dt = 200 \text{ A/}\mu\text{s}$	-	6.2	11			
Reverse recovery charge	Q <sub>rr1</sub>	T <sub>J</sub> = 25 °C	$V_{\rm R} = 200 \text{ V}$	-	140	380			
neverse recovery charge	Q <sub>rr2</sub>	T <sub>J</sub> = 125 °C		-	335	880	110		
Peak rate of fall of	dI <sub>(rec)M</sub> /dt1	T <sub>J</sub> = 25 °C		-	133	-	- A/µs		
recovery current during t <sub>b</sub>	dI <sub>(rec)M</sub> /dt2	T <sub>J</sub> = 125 °C		-	85	=	- Αν μδ		

THERMAL - MECHANICAL SPECIFICATIONS										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Lead temperature	T <sub>lead</sub>	0.063" from case (1.6 mm) for 10 s	-	-	300	°C				
Thermal resistance, junction to case	R <sub>thJC</sub>		-	-	1.7	K/W				
Thermal resistance, junction to ambient	R <sub>thJA</sub>	Typical socket mount	-	-	40	N/W				
Weight			-	2.0	-	g				
vveignt			-	0.07	-	oz.				
Marking device		Case style D <sup>2</sup> PAK	HFA08TB120S							

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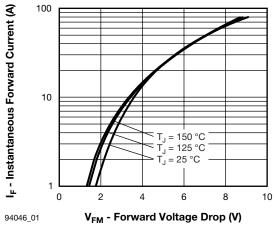


### **HEXFRED®** Ultrafast Soft Recovery Diode, 8 A

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I<sub>R</sub> - Reverse Current (µA) = 125 °C 100 10 0.1 0.01 300 1200

Fig. 1 - Maximum Forward Voltage Drop Characteristics

V<sub>R</sub> - Reverse Voltage (V) Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

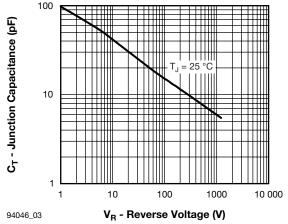


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

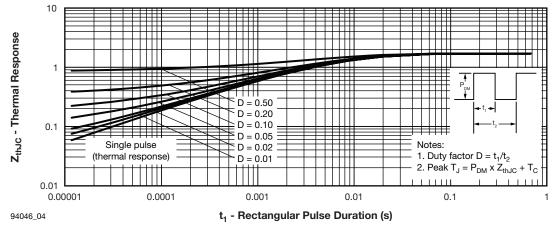


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

### VS-HFA08TB120SPbF

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# HEXFRED® Ultrafast Soft Recovery Diode, 8 A



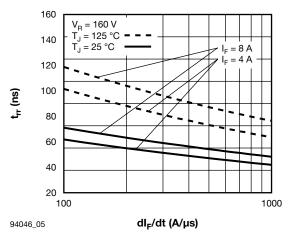


Fig. 5 - Typical Reverse Recovery Time vs. dI<sub>F</sub>/dt

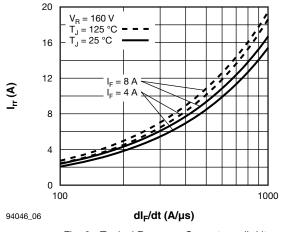


Fig. 6 - Typical Recovery Current vs.  $dI_F/dt$ 

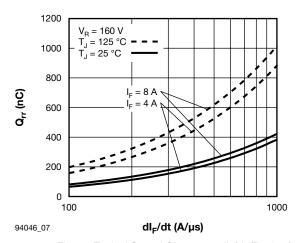


Fig. 7 - Typical Stored Charge vs. dI<sub>F</sub>/dt (Per Leg)

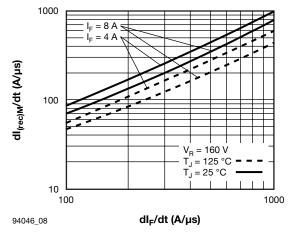


Fig. 8 - Typical  $dI_{(rec)M}/dt$  vs.  $dI_F/dt$ 

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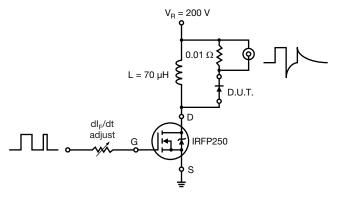
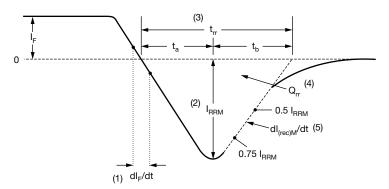


Fig. 9 - Reverse Recovery Parameter Test Circuit



- (1) dl<sub>F</sub>/dt rate of change of current through zero crossing
- (2)  $I_{RRM}$  peak reverse recovery current
- (3)  $\rm t_{rr}$  reverse recovery time measured from zero crossing point of negative going  $\rm l_{r}$  to point where a line passing through 0.75  $\rm l_{RRM}$  and 0.50  $\rm l_{RRM}$  extrapolated to zero current.
- (4)  $\rm Q_{rr}$  area under curve defined by  $\rm t_{rr}$  and  $\rm I_{RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) dl<sub>(rec)M</sub>/dt - peak rate of change of current during t<sub>b</sub> portion of t<sub>rr</sub>

Fig. 10 - Reverse Recovery Waveform and Definitions

### VS-HFA08TB120SPbF

### Vishay High Power Products

# HEXFRED® Ultrafast Soft Recovery Diode, 8 A



### **ORDERING INFORMATION TABLE**

**Device code** 

VS-	HF	A	08	ТВ	120	S	TRL	PbF
1	2	3	4	5	6	7	8	9

- 1 HPP product suffix
- 2 HEXFRED® family
- **3** Process designator: A = Electron irradiated
- 4 Current rating (08 = 8 A)
- Package outline (TB = TO-220, 2 leads)
- 6 Voltage rating (120 = 1200 V)
- $7 S = D^2PAK$
- None = Tube (50 pieces)
  - TRL = Tape and reel (left oriented)
  - TRR = Tape and reel (right oriented)
- 9 PbF = Lead (Pb)-free

LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?95046						
Part marking information	www.vishay.com/doc?95054						
Packaging information	www.vishay.com/doc?95032						

www.vishay.com

For technical questions, contact: diodestech@vishay.com

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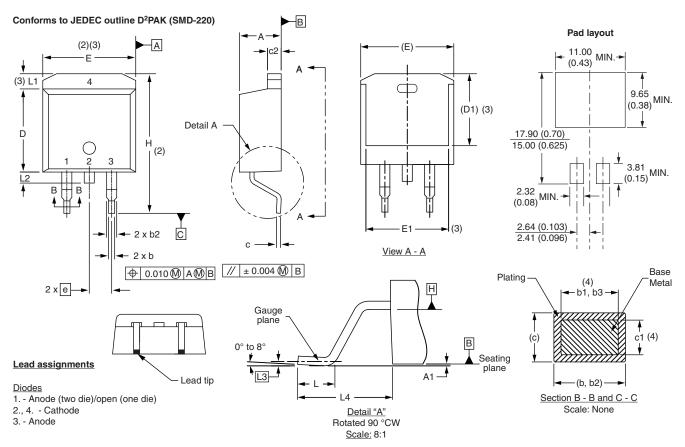
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### Vishay Semiconductors

### D<sup>2</sup>PAK

### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIM	IETERS	INC	HES	NOTES	NOTES	SYMBOL	MILLIN	IETERS	INCHES		NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES		STINIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	) BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2	1	L4	4.78	5.28	0.188	0.208	

#### Notes

- $^{(1)}$  Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC outline TO-263AB

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